ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Pai	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su compasses	bstances v all lower	vithin the manufactu level materials for v	urer listed which the	item. Note: nanufacture	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Material					rials and N	ls and Mfg Information			
upplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority				Respon	Response Date*			
onsemi								2024-04-24						
ntact Name Title - Contact					Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Enviro C			o Compliance		NA			Produ	Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			entative		Phone - Representative*			Email ·	Email - Representative*					
Product-Env-Stewards Product E			luct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Requester Item Number Mfr Item 1		Number Mfr Item Name			Effective Date	e Date Version Manufacturing Site			Weight*	UOM	Unit Type		
	N25S81	N25S818HAT21IT GENERAL SALE		ES (ULP)		2024-04-24		T	TH6		32.92	mg	Each	
Ianufacturing Proccess Informa	tion							·						
Terminal Plating / Grid Array M	aterial T	ial Terminal Base Alloy		J-STD-020 MSI	Rating	Peak Process Body Tempe		emperature	ture Max Time at Peak Temp		ture Num	ber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		3		260		С	30	seco	nds 3			
omments														
TTENTION: MSL 3 Rated item require	es Bake and L	Dry Pack (after	electrical test)											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.65	mg	Supplier	Silicon (Si)	7440-21-3		1.65	mg
Die Attach	0.9	mg		Epoxy resin	proprietary data		0.18	mg
			Supplier	Silver (Ag)	7440-22-4		0.72	mg
Lead Frame	10.6	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0159	mg
			Supplier	Silicon (Si)	7440-21-3		0.0689	mg
			В	Nickel (Ni)	7440-02-0		0.318	mg
			Supplier	Copper (Cu)	7440-50-8		10.1972	mg
Mold Compound-Black	19.11	mg		Epoxy resin	proprietary data		0.9555	mg
			Supplier	Phenolic Resin	Proprietary Data		0.3822	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.4778	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0956	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		17.199	mg
Plating	0.44	mg	Supplier	Tin (Sn)	7440-31-5		0.44	mg
Wire Bond - Au	0.22	mg	Supplier	Gold (Au)	7440-57-5		0.22	mg